

ADA4505-2/ADA4505-4

FEATURES

PSRR: 100 dB minimum
CMRR: 105 dB typical
Very low supply current: 10 μ A per amplifier maximum
1.8 V to 5 V single-supply or ± 0.9 V to ± 2.5 V dual-supply operation
Rail-to-rail input and output
3 mV offset voltage maximum
Very low input bias current: 0.5 pA typical

APPLICATIONS

Pressure and position sensors
Remote security
Medical monitors
Battery-powered consumer equipment
Hazard detectors

GENERAL DESCRIPTION

The ADA4505-2/ADA4505-4 are dual and quad micropower amplifiers featuring rail-to-rail input and output swings while operating from a single 1.8 V to 5 V power supply or from dual ± 0.9 V to ± 2.5 V power supplies.

Employing a new circuit technology, these low cost amplifiers offer zero input crossover distortion (excellent PSRR and CMRR performance) and very low bias current, while operating with a supply current of less than 10 μ A per amplifier.

This combination of features makes the ADA4505-2/ADA4505-4 amplifiers ideal choices for battery-powered applications because they minimize errors due to power supply voltage variations over the lifetime of the battery, and maintain high CMRR even for a rail-to-rail op amp.

PIN CONFIGURATIONS



Figure 1. 8-Lead MSOP (RM-8)

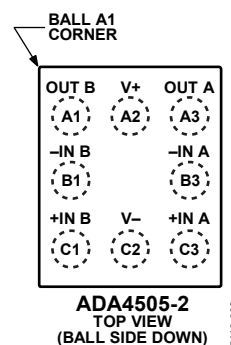


Figure 2. 8-Ball WLCSP (CB-8-2)

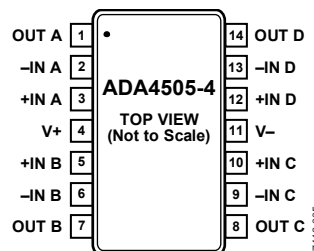


Figure 3. 14-Lead TSSOP (RU-14)

Remote battery-powered sensors, handheld instrumentation and consumer equipment, hazard detectors (for example, smoke, fire, and gas), and patient monitors can benefit from the features of the ADA4505-2/ADA4505-4 amplifiers.

The ADA4505-2/ADA4505-4 are specified for both the industrial temperature range (-40°C to $+85^{\circ}\text{C}$) and the extended industrial temperature range (-40°C to $+125^{\circ}\text{C}$). The ADA4505-2 dual amplifier is available in standard 8-lead MSOP and 8-ball WLCSP packages. The ADA4505-4 quad amplifier is available in a 14-lead TSSOP package.

The ADA4505-2/ADA4505-4 are members of a growing series of zero crossover op amps offered by Analog Devices, Inc., including the AD8506/AD8508, which also operate from a single 1.8 V to 5 V power supply or from dual ± 0.9 V to ± 2.5 V power supplies.

Rev. A

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

TABLE OF CONTENTS

Features	1	ESD Caution.....	5
Applications.....	1	Typical Performance Characteristics	6
Pin Configurations	1	Theory of Operation	14
General Description	1	Applications Information	16
Revision History	2	Pulse Oximeter Current Source	16
Specifications.....	3	Four-Pole Low-Pass Butterworth Filter for Glucose Monitor.....	17
Electrical Characteristics—5 V Operation.....	3	Outline Dimensions	18
Electrical Characteristics—1.8 V Operation	4	Ordering Guide	19
Absolute Maximum Ratings.....	5		
Thermal Resistance	5		

REVISION HISTORY

10/08—Rev. 0 to Rev. A

Added ADA4505-4, 8-Ball WLCSP, and 14-Lead TSSOP	Throughout
Change to Features Section	1
Added Figure 2 and Figure 3; Renumbered Sequentially	1
Changes to Table 1.....	3
Changes to Table 2.....	4
Changes to Thermal Resistance Section.....	5
Changes to Figure 22 and Figure 25.....	9
Changes to Figure 40 and Figure 43.....	12
Deleted Figure 46 and Figure 48.....	13
Change to Theory of Operation Section	14
Changes to Figure 52.....	16
Change to Four-Pole Low-Pass Butterworth Filter for Glucose Monitor Section.....	17
Updated Outline Dimensions	18
Changes to Ordering Guide	19

7/08—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION

$V_{SY} = 5\text{ V}$, $V_{CM} = V_{SY}/2$, $T_A = 25^\circ\text{C}$, $R_L = 100\text{ k}\Omega$ to GND, unless otherwise specified.

Table 1.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	V _{OS}	0 V ≤ V _{CM} ≤ 5 V −40°C ≤ T _A ≤ +125°C		0.5	3 4	mV mV
Input Bias Current	I _B	−40°C ≤ T _A ≤ +85°C −40°C ≤ T _A ≤ +125°C		0.5	2 50 375	pA pA pA
Input Offset Current	I _{OS}	−40°C ≤ T _A ≤ +85°C −40°C ≤ T _A ≤ +125°C		0.05	1 25 130	pA pA pA
Input Voltage Range		−40°C ≤ T _A ≤ +125°C	0		5	V
Common-Mode Rejection Ratio	CMRR	0 V ≤ V _{CM} ≤ 5 V −40°C ≤ T _A ≤ +85°C −40°C ≤ T _A ≤ +125°C	90 90 85	105		dB dB dB
Large Signal Voltage Gain	A _{VO}	0.05 V ≤ V _{OUT} ≤ 4.95 V −40°C ≤ T _A ≤ +125°C	105 100	120		dB dB
Offset Voltage Drift	ΔV _{OS} /ΔT	−40°C ≤ T _A ≤ +125°C		2		μV/°C
Input Resistance	R _{IN}			220		GΩ
Input Capacitance Differential Mode	C _{INDM}			2.5		pF
Input Capacitance Common Mode	C _{INCM}			4.7		pF
OUTPUT CHARACTERISTICS						
Output Voltage High	V _{OH}	R _L = 100 kΩ to GND −40°C ≤ T _A ≤ +125°C	4.98 4.98	4.99		V V
		R _L = 10 kΩ to GND −40°C ≤ T _A ≤ +125°C	4.9 4.9	4.95		V V
Output Voltage Low	V _{OL}	R _L = 100 kΩ to V _{SY} −40°C ≤ T _A ≤ +125°C		2	5	mV mV
		R _L = 10 kΩ to V _{SY} −40°C ≤ T _A ≤ +125°C		10	25 25	mV mV
Short-Circuit Limit	I _{SC}	V _{OUT} = V _{SY} or GND		±40		mA
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	V _{SY} = 1.8 V to 5 V −40°C ≤ T _A ≤ +85°C −40°C ≤ T _A ≤ +125°C	100 100 95	110		dB dB dB
Supply Current per Amplifier	I _{SY}	V _{OUT} = V _{SY} /2 −40°C ≤ T _A ≤ +125°C		7	10 15	μA μA
DYNAMIC PERFORMANCE						
Slew Rate	SR	R _L = 100 kΩ, C _L = 20 pF, G = 1		6		mV/μs
Gain Bandwidth Product	GBP	R _L = 1 MΩ, C _L = 20 pF, G = 1		50		kHz
Phase Margin	Φ _M	R _L = 1 MΩ, C _L = 20 pF, G = 1		52		Degrees
NOISE PERFORMANCE						
Voltage Noise	e _n p-p	f = 0.1 Hz to 10 Hz		2.95		μV p-p
Voltage Noise Density	e _n	f = 1 kHz		65		nV/√Hz
Current Noise Density	i _n	f = 1 kHz		20		fA/√Hz

ADA4505-2/ADA4505-4

ELECTRICAL CHARACTERISTICS—1.8 V OPERATION

$V_{SY} = 1.8 \text{ V}$, $V_{CM} = V_{SY}/2$, $T_A = 25^\circ\text{C}$, $R_L = 100 \text{ k}\Omega$ to GND, unless otherwise specified.

Table 2.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	V_{OS}	$0 \text{ V} \leq V_{CM} \leq 1.8 \text{ V}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$		0.5	3	mV
Input Bias Current	I_B	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$		0.5	4	pA
Input Offset Current	I_{OS}	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$		0.05	50	pA
Input Voltage Range		$-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$			375	pA
Common-Mode Rejection Ratio	CMRR	$0 \text{ V} \leq V_{CM} \leq 1.8 \text{ V}$ $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	0		1	pA
Large Signal Voltage Gain	A_{VO}	$0.05 \text{ V} \leq V_{OUT} \leq 1.75 \text{ V}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	85	100	25	pA
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	85		130	pA
Input Resistance	R_{IN}		80		1.8	V
Input Capacitance Differential Mode	C_{INDM}		95	115		dB
Input Capacitance Common Mode	C_{INCM}		95			dB
OUTPUT CHARACTERISTICS						
Output Voltage High	V_{OH}	$R_L = 100 \text{ k}\Omega$ to GND $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	1.78	1.79		V
Output Voltage Low	V_{OL}	$R_L = 10 \text{ k}\Omega$ to GND $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	1.78	1.75		V
Short-Circuit Limit	I_{SC}	$R_L = 100 \text{ k}\Omega$ to V_{SY} $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$ $R_L = 10 \text{ k}\Omega$ to V_{SY} $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$ $V_{OUT} = V_{SY}$ or GND	1.65		5	V
Power Supply Rejection Ratio	PSRR	$V_{SY} = 1.8 \text{ V}$ to 5 V $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	2		5	mV
Supply Current per Amplifier	I_{SY}	$V_{OUT} = V_{SY}/2$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	12		25	mV
POWER SUPPLY						
Power Supply Rejection Ratio	PSRR	$V_{SY} = 1.8 \text{ V}$ to 5 V $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	100	110		dB
Supply Current per Amplifier	I_{SY}	$V_{OUT} = V_{SY}/2$ $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$	100		10	dB
DYNAMIC PERFORMANCE						
Slew Rate	SR	$R_L = 100 \text{ k}\Omega$, $C_L = 20 \text{ pF}$, $G = 1$	95	7	15	dB
Gain Bandwidth Product	GBP	$R_L = 1 \text{ M}\Omega$, $C_L = 20 \text{ pF}$, $G = 1$				μA
Phase Margin	Φ_M	$R_L = 1 \text{ M}\Omega$, $C_L = 20 \text{ pF}$, $G = 1$				μA
NOISE PERFORMANCE						
Voltage Noise	e_n p-p	$f = 0.1 \text{ Hz}$ to 10 Hz		2.95		mV/ μs
Voltage Noise Density	e_n	$f = 1 \text{ kHz}$		65		kHz
Current Noise Density	i_n	$f = 1 \text{ kHz}$		20		Degrees

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	5.5 V
Input Voltage	$\pm V_{SY} \pm 0.1$ V
Input Current ¹	± 10 mA
Differential Input Voltage ²	$\pm V_{SY}$
Output Short-Circuit Duration to GND	Indefinite
Storage Temperature Range	–65°C to +150°C
Operating Temperature Range	–40°C to +125°C
Junction Temperature Range	–65°C to +150°C
Lead Temperature (Soldering, 60 sec)	300°C

¹ Input pins have clamp diodes to the supply pins. Input current should be limited to 10 mA or less whenever the input signal exceeds the power supply rail by 0.5 V.

² Differential input voltage is limited to 5 V or the supply voltage, whichever is less.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages. This was measured using a standard 2-layer board, unless otherwise specified.

Table 4. Thermal Resistance

Package Type	θ_{JA}	θ_{JB} ¹	θ_{JC}	Unit
8-Lead MSOP (RM-8)	206	N/A	44	°C/W
8-Ball WLCSP (CB-8-2)				
2-Layer PCB (1SOP)	178	42	N/A	°C/W
4-Layer PCB (2SOP)	82	23	N/A	°C/W
14-Lead TSSOP (RU-14)	180	N/A	35	°C/W

¹ Junction-to-board thermal resistance.

ESD CAUTION



ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$, unless otherwise noted.

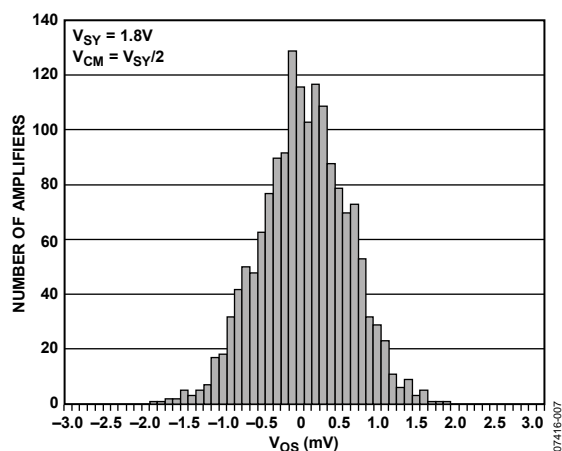


Figure 4. Input Offset Voltage Distribution

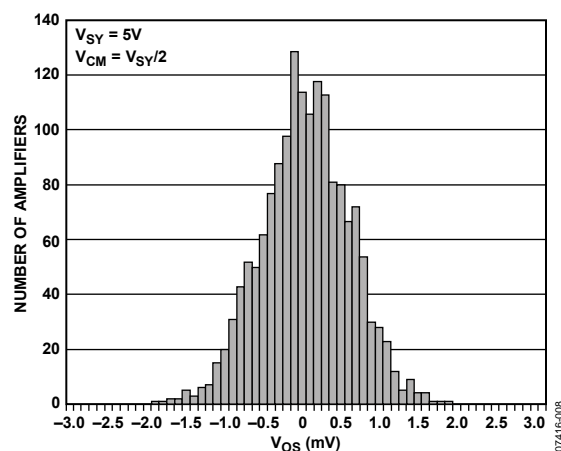


Figure 7. Input Offset Voltage Distribution

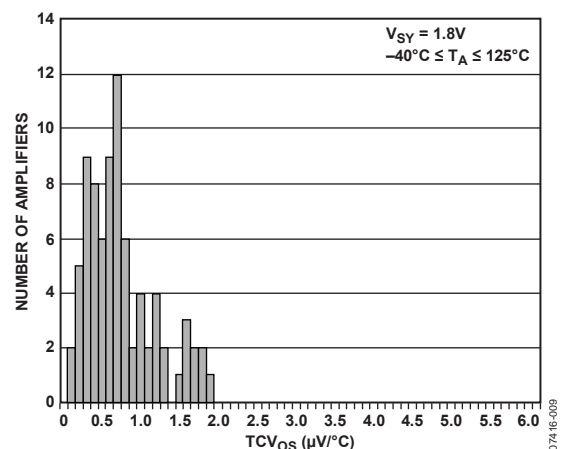


Figure 5. Input Offset Voltage Drift Distribution

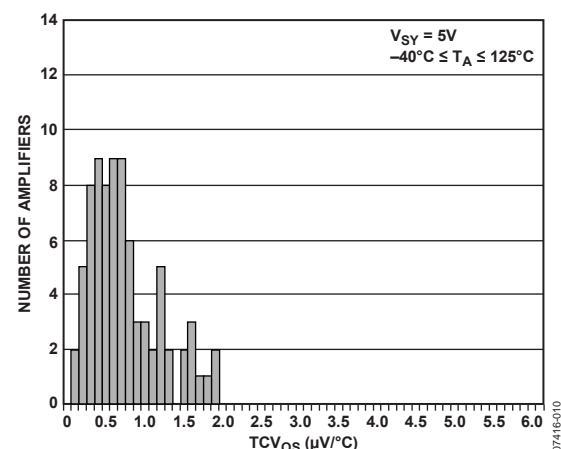


Figure 8. Input Offset Voltage Drift Distribution

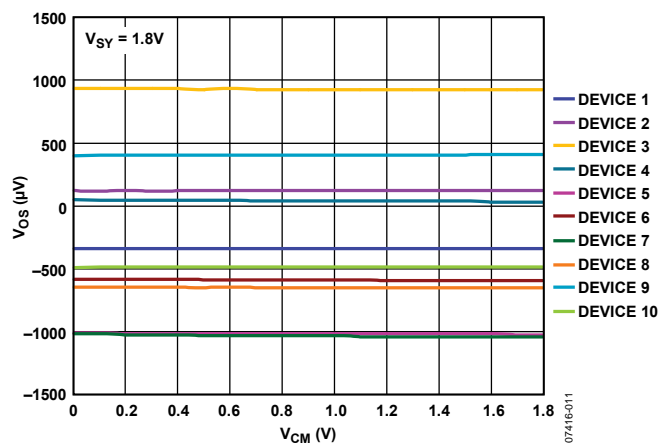


Figure 6. Input Offset Voltage vs. Common-Mode Voltage

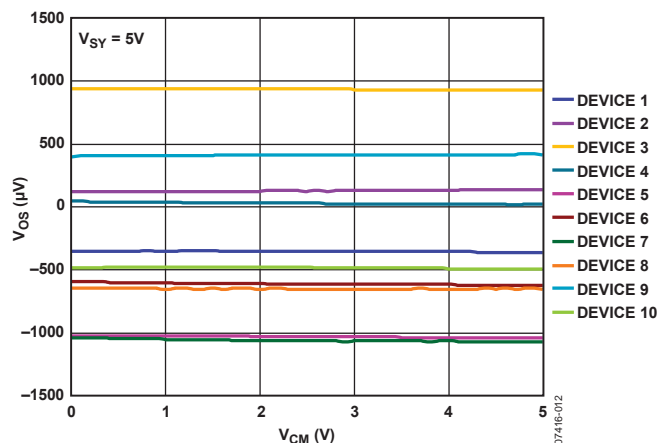


Figure 9. Input Offset Voltage vs. Common-Mode Voltage

$T_A = 25^\circ\text{C}$, unless otherwise noted.

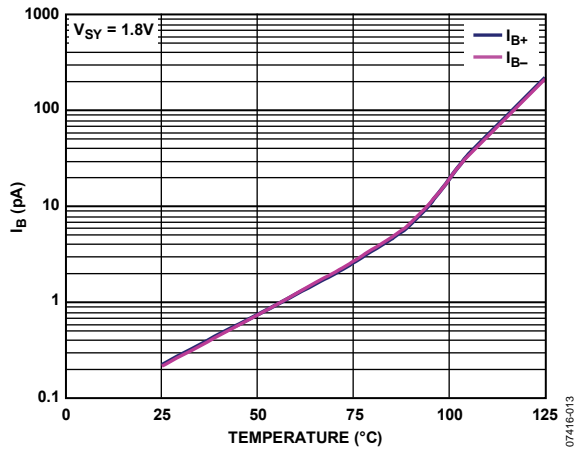


Figure 10. Input Bias Current vs. Temperature

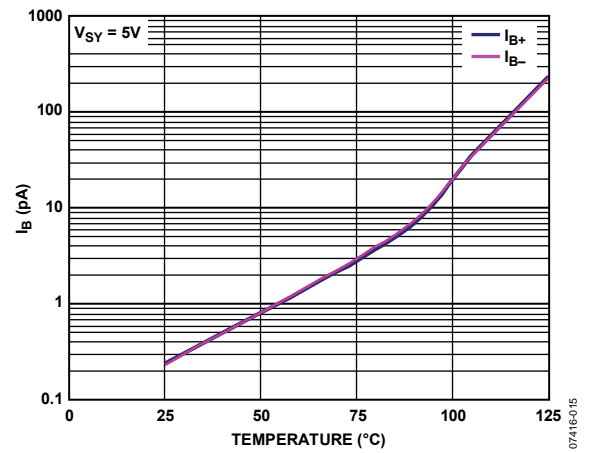


Figure 13. Input Bias Current vs. Temperature

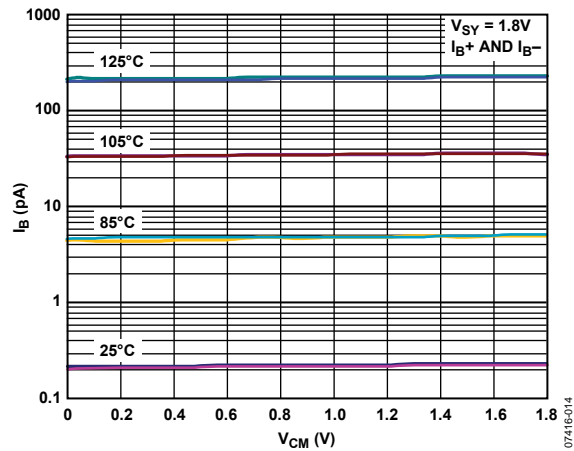


Figure 11. Input Bias Current vs. Common-Mode Voltage and Temperature

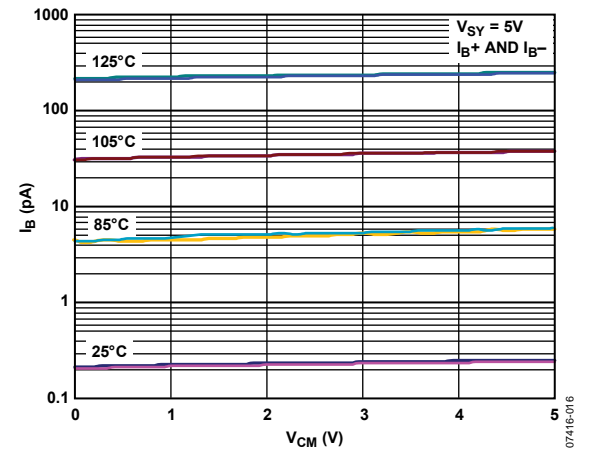


Figure 14. Input Bias Current vs. Common-Mode Voltage and Temperature

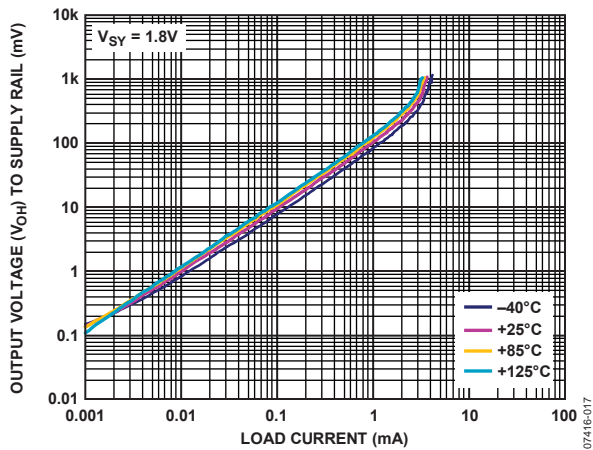


Figure 12. Output Voltage (V_{OH}) to Supply Rail vs. Load Current and Temperature

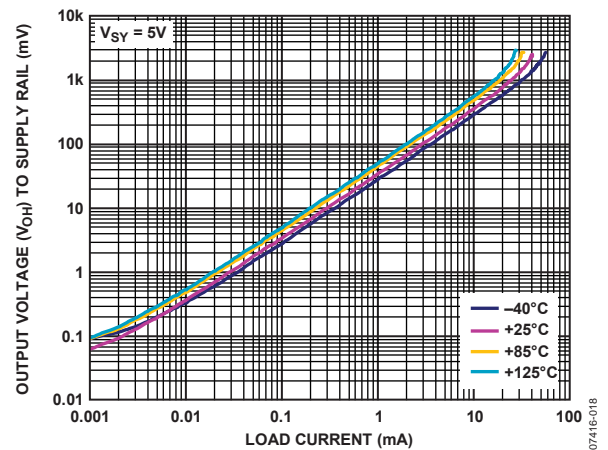


Figure 15. Output Voltage (V_{OH}) to Supply Rail vs. Load Current and Temperature

ADA4505-2/ADA4505-4

$T_A = 25^\circ\text{C}$, unless otherwise noted.

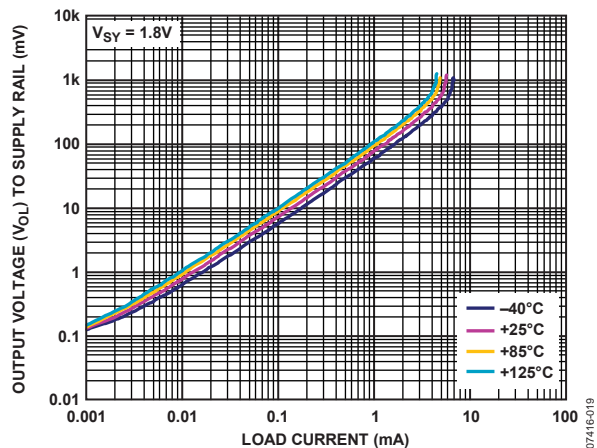


Figure 16. Output Voltage (V_{OL}) to Supply Rail vs. Load Current and Temperature

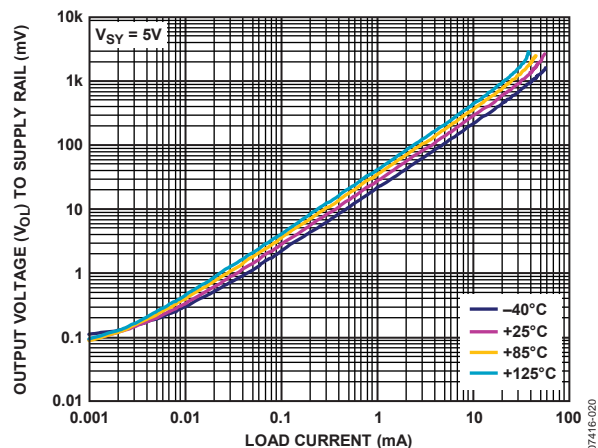


Figure 19. Output Voltage (V_{OL}) to Supply Rail vs. Load Current and Temperature

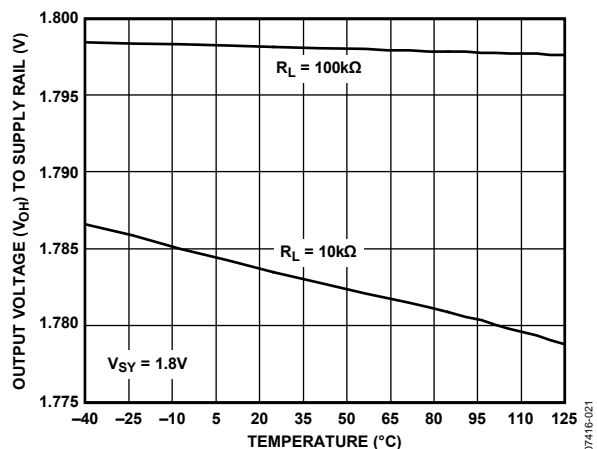


Figure 17. Output Voltage (V_{OH}) to Supply Rail vs. Temperature

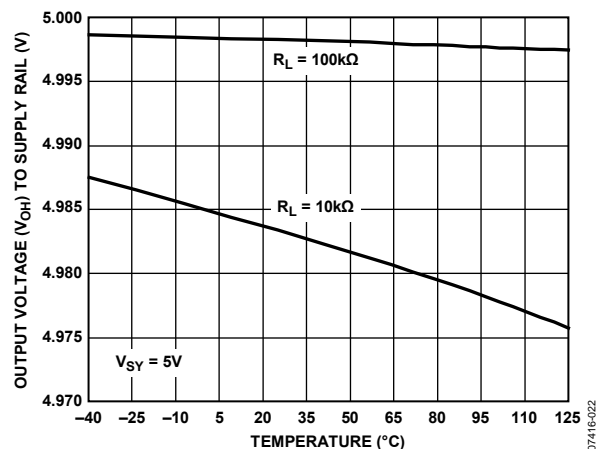


Figure 20. Output Voltage (V_{OH}) to Supply Rail vs. Temperature

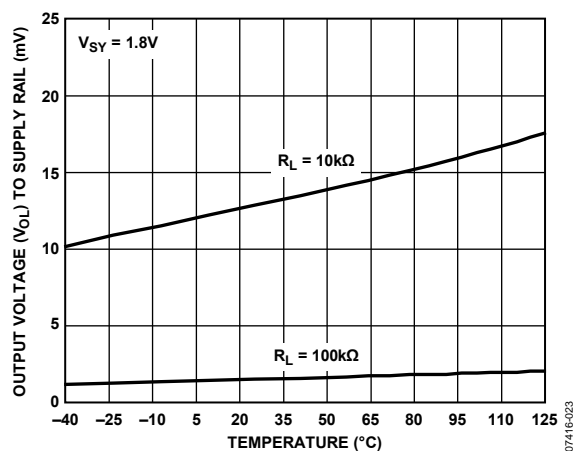


Figure 18. Output Voltage (V_{OL}) to Supply Rail vs. Temperature

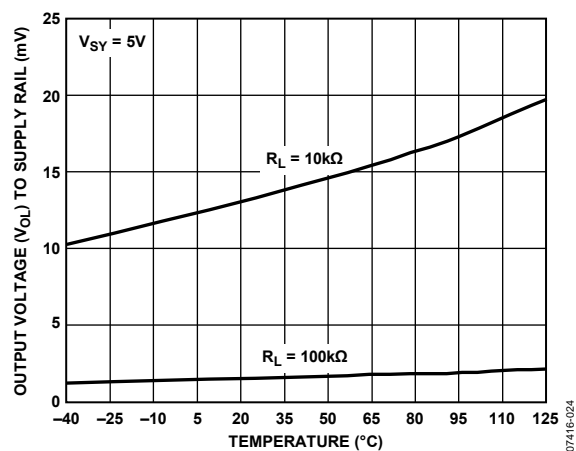


Figure 21. Output Voltage (V_{OL}) to Supply Rail vs. Temperature

$T_A = 25^\circ\text{C}$, unless otherwise noted.

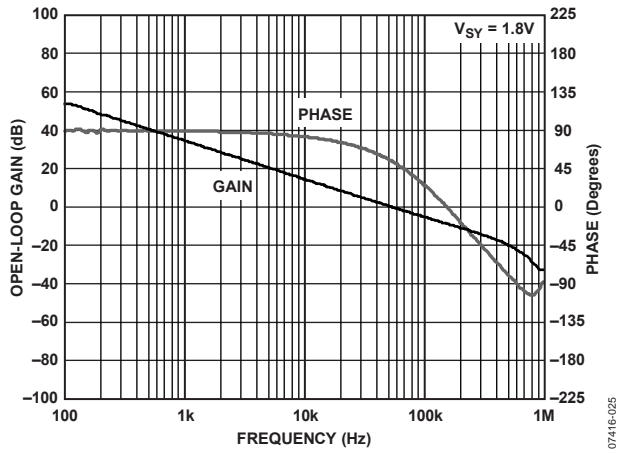


Figure 22. Open-Loop Gain and Phase vs. Frequency

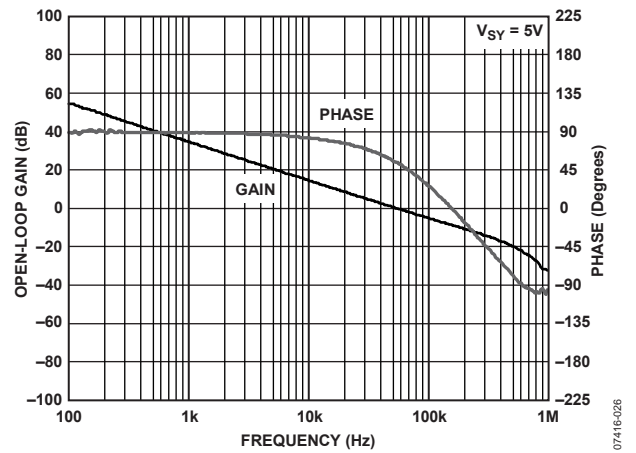


Figure 25. Open-Loop Gain and Phase vs. Frequency

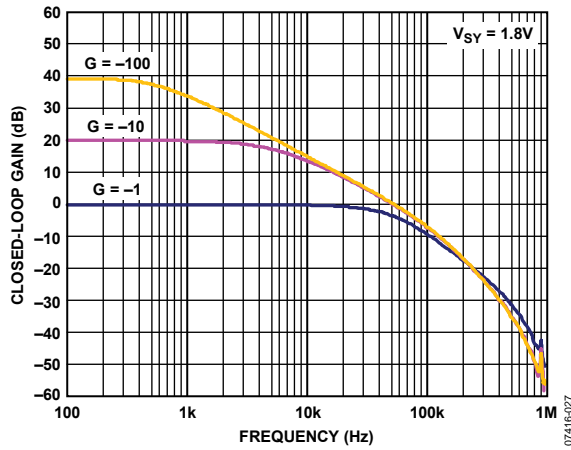


Figure 23. Closed-Loop Gain vs. Frequency

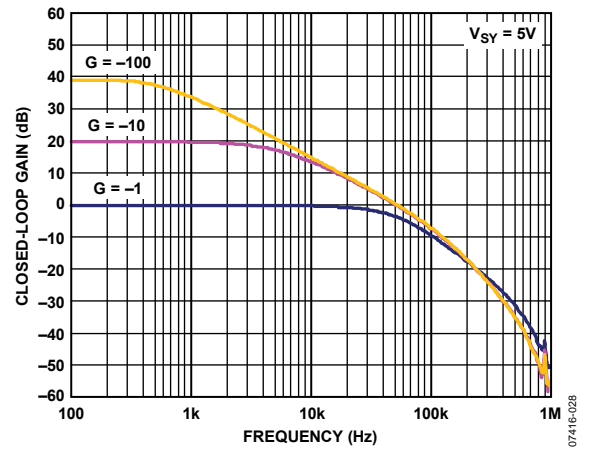


Figure 26. Closed-Loop Gain vs. Frequency

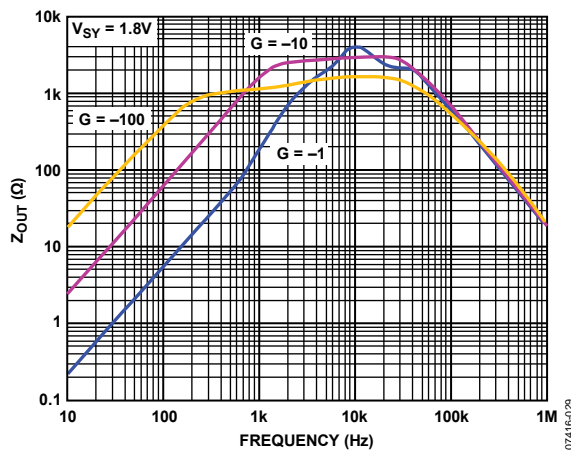


Figure 24. Output Impedance vs. Frequency

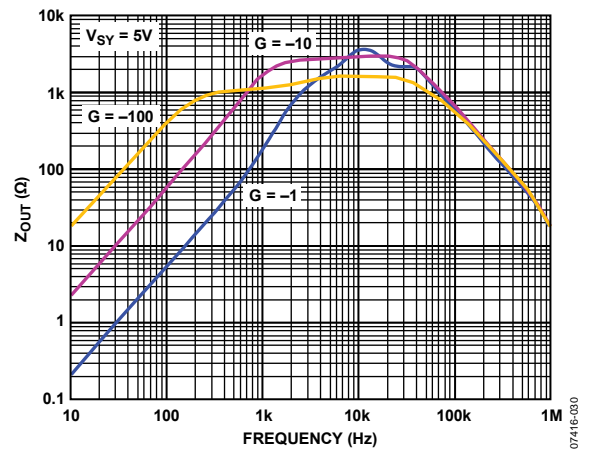


Figure 27. Output Impedance vs. Frequency

ADA4505-2/ADA4505-4

$T_A = 25^\circ\text{C}$, unless otherwise noted.

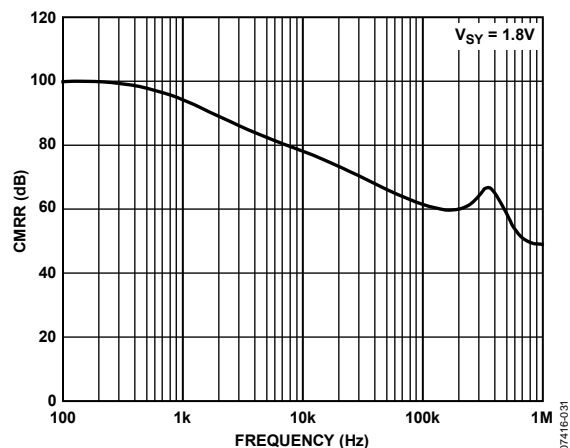


Figure 28. CMRR vs. Frequency

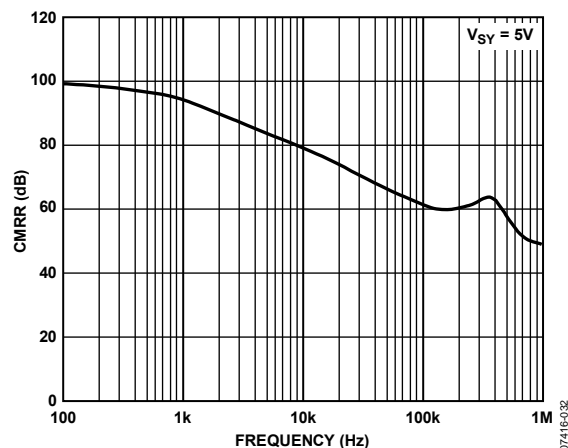


Figure 31. CMRR vs. Frequency

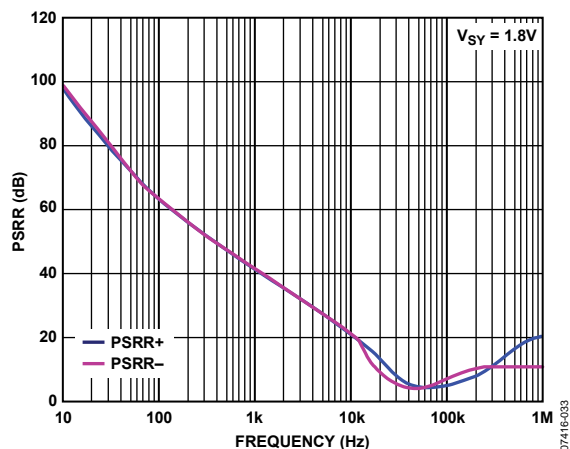


Figure 29. PSRR vs. Frequency

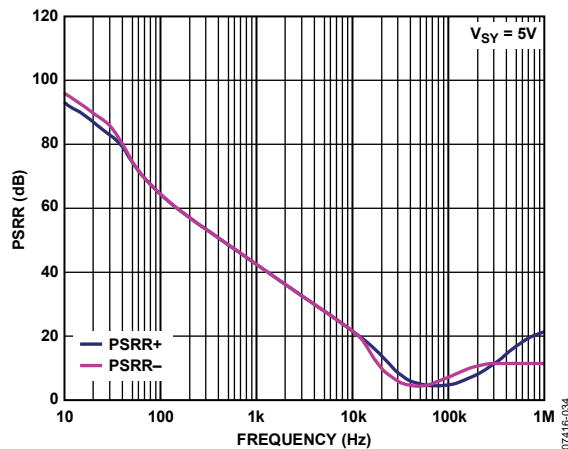


Figure 32. PSRR vs. Frequency

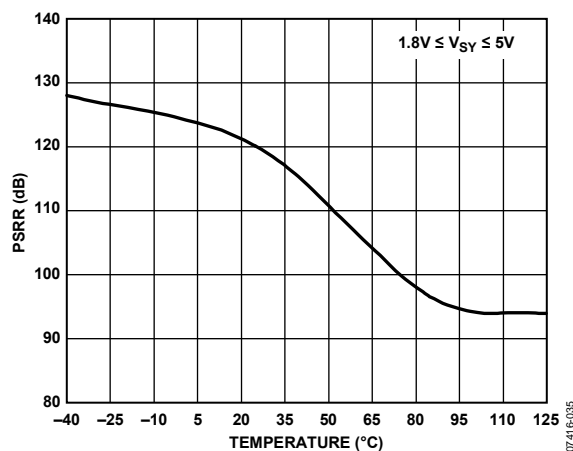


Figure 30. PSRR vs. Temperature

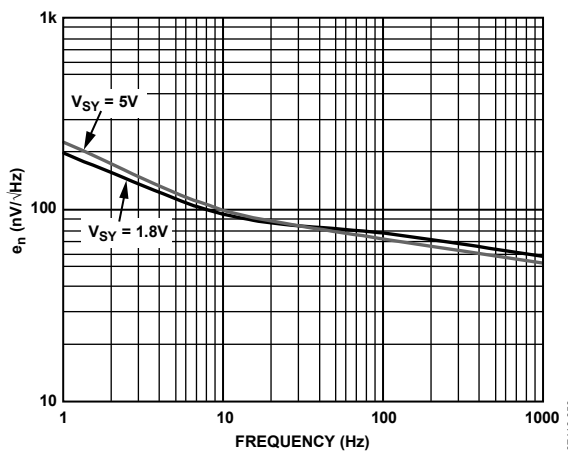


Figure 33. Voltage Noise Density vs. Frequency

$T_A = 25^\circ\text{C}$, unless otherwise noted.

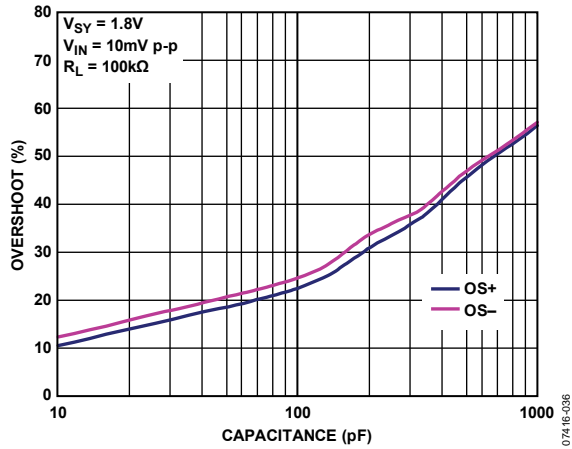


Figure 34. Small Signal Overshoot vs. Load Capacitance

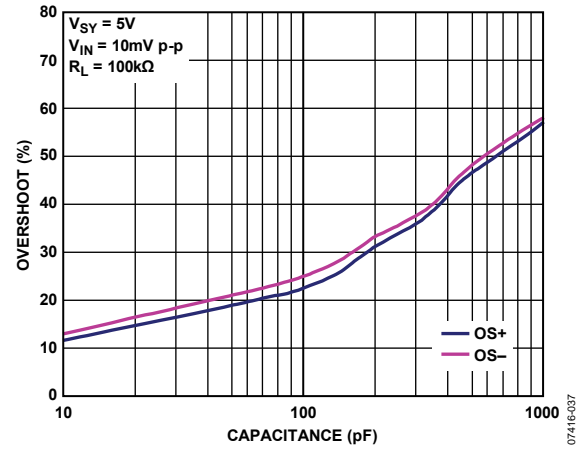


Figure 37. Small Signal Overshoot vs. Load Capacitance

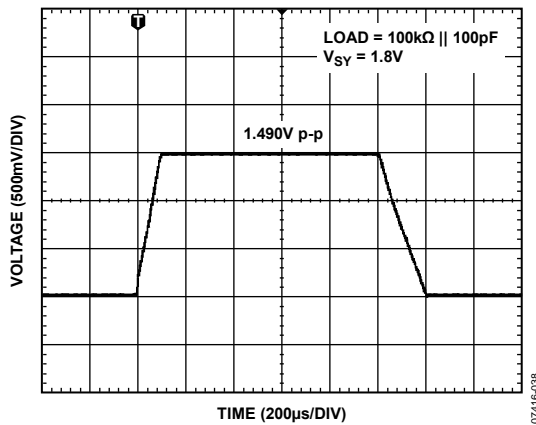


Figure 35. Large Signal Transient Response

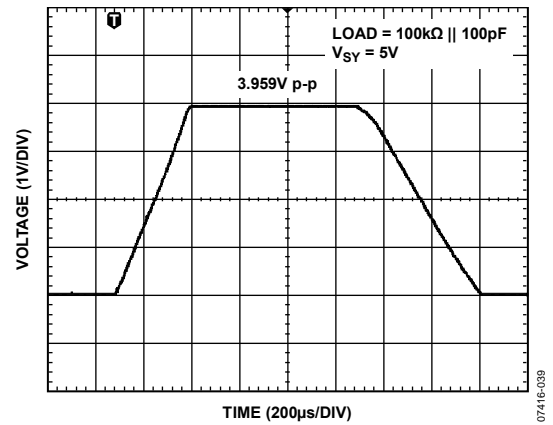


Figure 38. Large Signal Transient Response

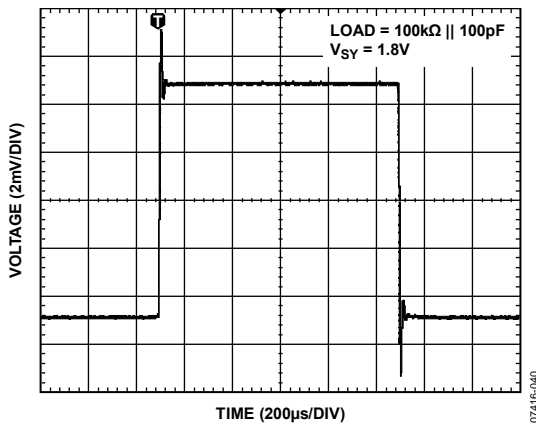


Figure 36. Small Signal Transient Response

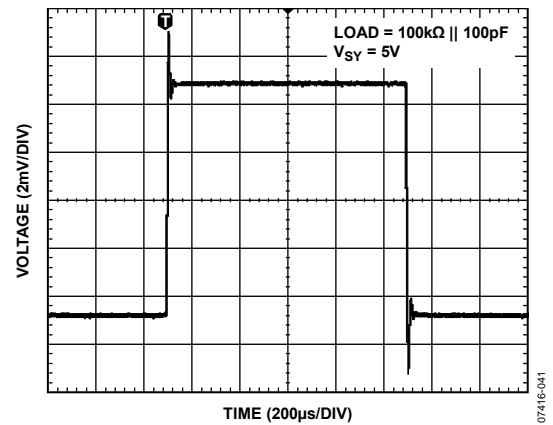


Figure 39. Small Signal Transient Response

ADA4505-2/ADA4505-4

$T_A = 25^\circ\text{C}$, unless otherwise noted.

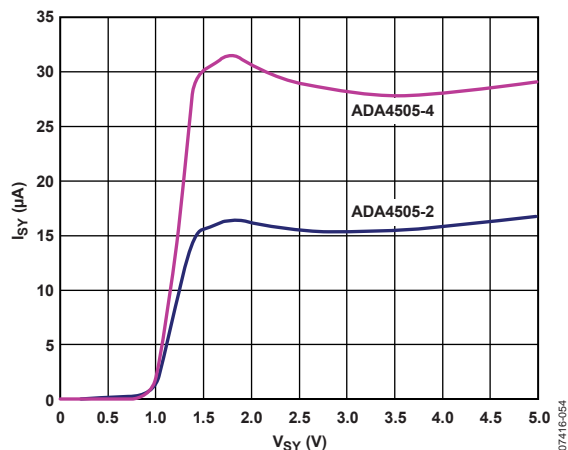


Figure 40. Supply Current vs. Supply Voltage

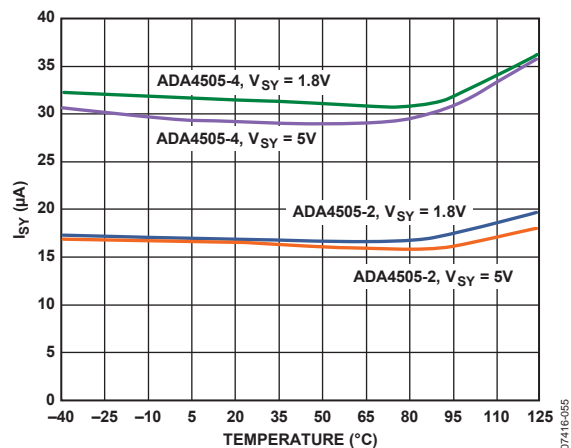


Figure 43. Total Supply Current vs. Temperature

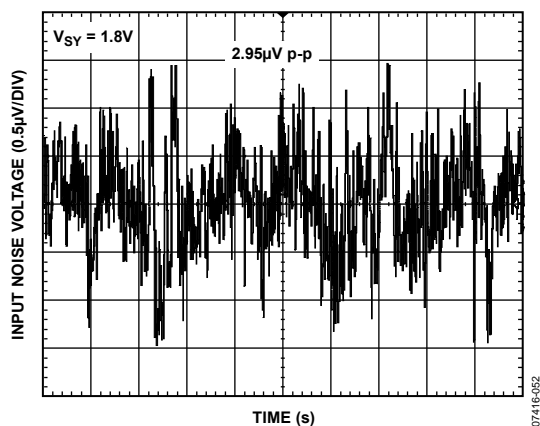


Figure 41. 0.1 Hz to 10 Hz Noise

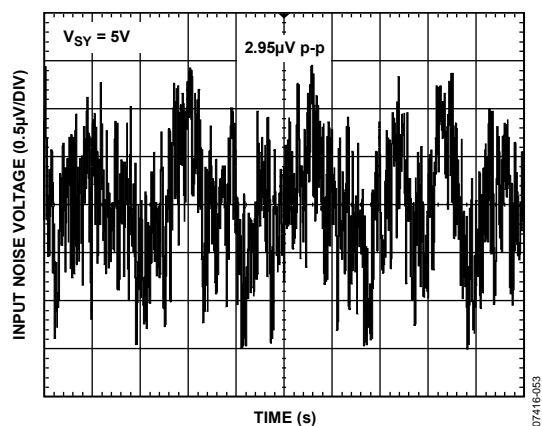


Figure 44. 0.1 Hz to 10 Hz Noise

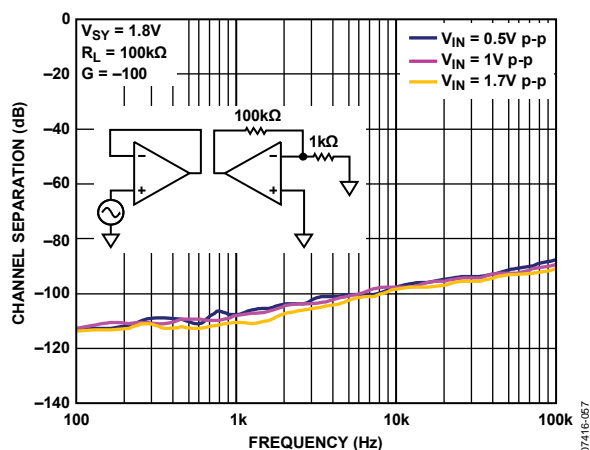


Figure 42. Channel Separation vs. Frequency

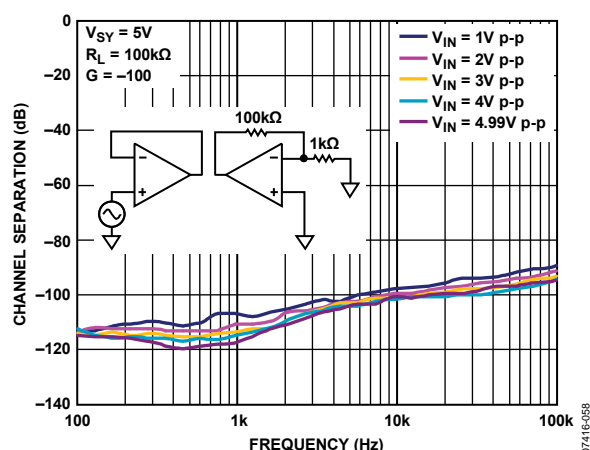


Figure 45. Channel Separation vs. Frequency

$T_A = 25^\circ\text{C}$, unless otherwise noted.

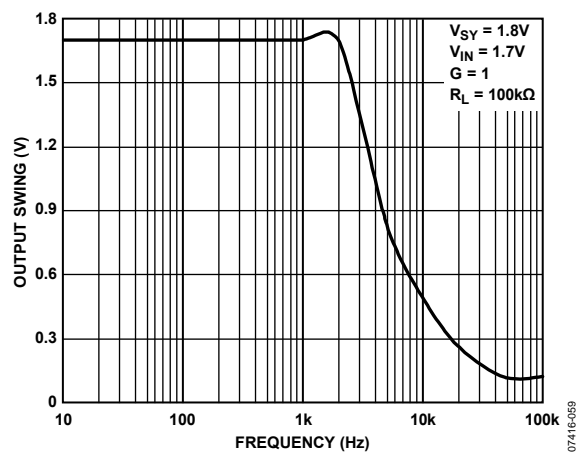


Figure 46. Output Swing vs. Frequency

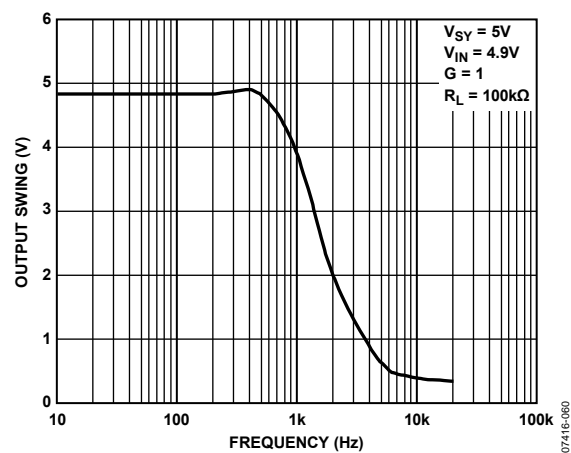


Figure 47. Output Swing vs. Frequency

THEORY OF OPERATION

The ADA4505-2/ADA4505-4 are unity-gain stable CMOS rail-to-rail input/output operational amplifiers designed to optimize performance in current consumption, PSRR, CMRR, and zero crossover distortion, all embedded in a small package. The typical offset voltage is 500 μV , with a low peak-to-peak voltage noise of 2.95 μV from 0.1 Hz to 10 Hz and a voltage noise density of 65 nV/ $\sqrt{\text{Hz}}$ at 1 kHz.

The ADA4505-2/ADA4505-4 are designed to solve two key problems in low voltage battery-powered applications: battery voltage decrease over time and rail-to-rail input stage distortion.

In battery-powered applications, the supply voltage available to the IC is the voltage of the battery. Unfortunately, the voltage of a battery decreases as it discharges itself through the load. This voltage drop over the lifetime of the battery causes an error in the output of the op amps. Some applications requiring precision measurements during the entire lifetime of the battery use voltage regulators to power up the op amps as a solution. If a design uses standard battery cells, the op amps experience a supply voltage change from roughly 3.2 V to 1.8 V during the lifetime of the battery. This means that for a PSRR of 70 dB minimum in a typical op amp, the input-referred offset error is approximately 440 μV . If the same application uses the ADA4505-2/ADA4505-4 with a 100 dB minimum PSRR, the error is only 14 μV . It is possible to calibrate this error out or to use an external voltage regulator to power the op amp, but these solutions can increase system cost and complexity. The ADA4505-2/ADA4505-4 solve the impasse with no additional cost or error-nullifying circuitry.

The second problem with battery-powered applications is the distortion caused by the standard rail-to-rail input stage. Using a CMOS non-rail-to-rail input stage (that is, a single differential pair) limits the input voltage to approximately one V_{GS} (gate-source voltage) away from one of the supply lines. Because V_{GS} for normal operation is commonly over 1 V, a single differential pair input stage op amp greatly restricts the allowable input voltage range when using a low supply voltage. This limitation restricts the number of applications where the non-rail-to-rail input op amp was originally intended to be used. To solve this problem, a dual differential pair input stage is usually implemented (see Figure 48); however, this technique has its own drawbacks.

One differential pair amplifies the input signal when the common-mode voltage is on the high end, whereas the other pair amplifies the input signal when the common-mode voltage is on the low end. This method also requires control circuitry to operate the two differential pairs appropriately. Unfortunately, this topology leads to a very noticeable and undesirable problem: if the signal level moves through the range where one input stage turns off and the other one turns on, noticeable distortion occurs (see Figure 49).

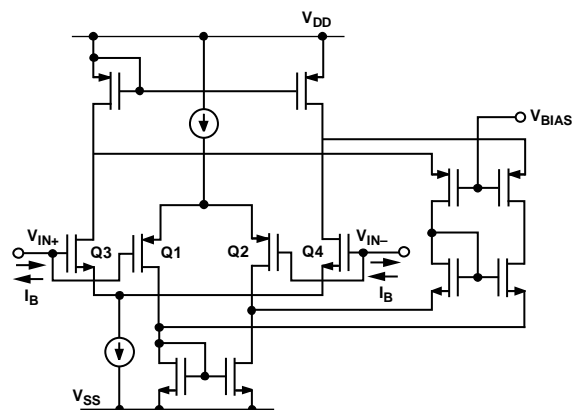


Figure 48. Typical Dual Differential Pair Input Stage Op Amp (Dual PMOS Q1 and Q2 Transistors Form the Lower End of the Input Voltage Range; Dual NMOS Q3 and Q4 Transistors Form the Upper End)

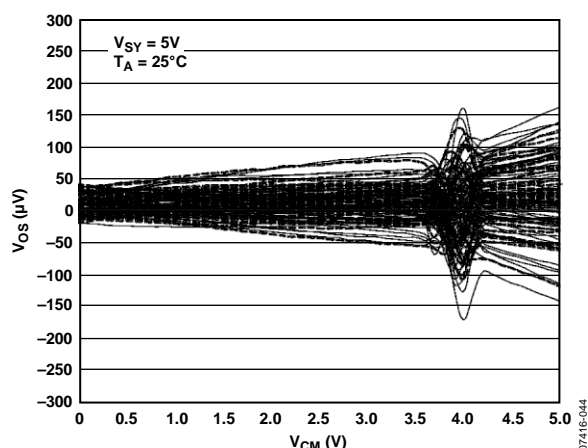


Figure 49. Typical Input Offset Voltage vs. Common-Mode Voltage Response in a Dual Differential Pair Input Stage Op Amp (Powered by 5 V Supply; Results of Approximately 100 Units per Graph Are Displayed)

This distortion forces the designer to devise impractical ways to avoid the crossover distortion areas, therefore narrowing the common-mode dynamic range of the operational amplifier. The ADA4505-2/ADA4505-4 solve this crossover distortion problem by using an on-chip charge pump to power the input differential pair. The charge pump creates a supply voltage higher than the voltage of the battery, allowing the input stage to handle a wide range of input signal voltages without using a second differential pair. With this solution, the input voltage can vary from one supply extreme to the other with no distortion, thereby restoring the full common-mode dynamic range of the op amp.

The charge pump has been carefully designed so that switching noise components at any frequency, both within and beyond the amplifier bandwidth, are much lower than the thermal noise floor. Therefore, the spurious-free dynamic range (SFDR) is limited only by the input signal and the thermal or flicker noise. There is no intermodulation between input signal and switching noise.

Figure 50 displays a typical front-end section of an operational amplifier with an on-chip charge pump.

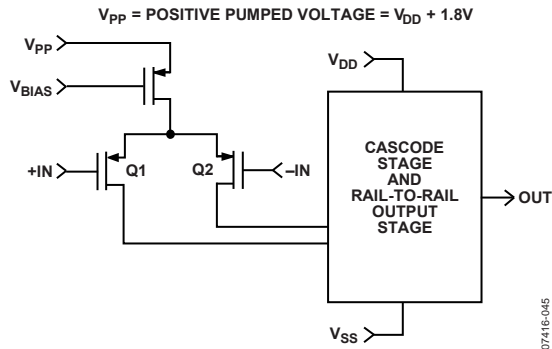


Figure 50. Typical Front-End Section of an Op Amp with Embedded Charge Pump

Figure 51 shows the typical response of two devices from Figure 9, which shows the input offset voltage vs. input common-mode voltage for 10 devices. Figure 51 is expanded to make it easier to compare with Figure 49, which shows the typical input offset voltage vs. common-mode voltage response in a dual differential pair input stage op amp.

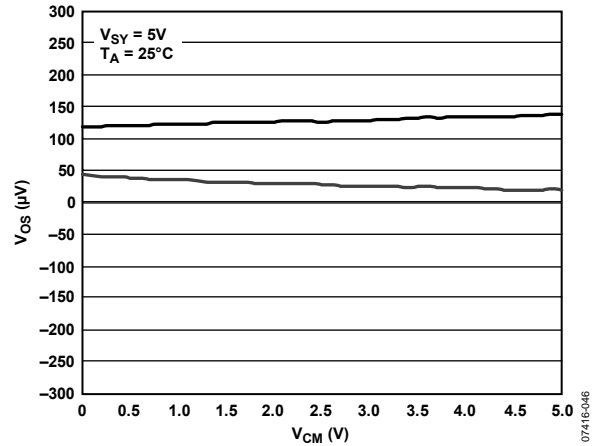


Figure 51. Input Offset Voltage vs. Input Common-Mode Voltage Response (Powered by a 5 V Supply; Results of Two Units Are Displayed)

This solution improves the CMRR performance tremendously. For example, if the input varies from rail to rail on a 2.5 V supply rail, using a part with a CMRR of 70 dB minimum, an input-referred error of 790 µV is introduced. Another part with a CMRR of 52 dB minimum generates a 6.3 mV error. The ADA4505-2/ADA4505-4 CMRR of 90 dB minimum causes only a 79 µV error. As with the PSRR error, there are complex ways to minimize this error, but the ADA4505-2/ADA4505-4 solve this problem without incurring unnecessary circuitry complexity or increased cost.

APPLICATIONS INFORMATION

PULSE OXIMETER CURRENT SOURCE

A pulse oximeter is a noninvasive medical device used for measuring continuously the percentage of hemoglobin (Hb) saturated with oxygen and the pulse rate of a patient. Hemoglobin that is carrying oxygen (oxyhemoglobin) absorbs light in the infrared (IR) region of the spectrum; hemoglobin that is not carrying oxygen (deoxyhemoglobin) absorbs visible red (R) light. In pulse oximetry, a clip containing two LEDs (sometimes more, depending on the complexity of the measurement algorithm) and the light sensor (photodiode) is placed on the finger or earlobe of the patient. One LED emits red light (600 nm to 700 nm) and the other emits light in the near IR (800 nm to 900 nm) region. The clip is connected by a cable to a processor unit. The LEDs are rapidly and sequentially excited by two current sources (one for each LED), whose dc levels depend on the LED being driven, based on manufacturer requirements; the detector is synchronized to capture the light from each LED as it is transmitted through the tissue.

An example design of a dc current source driving the red and infrared LEDs is shown in Figure 52. These dc current sources allow 62.5 mA and 101 mA to flow through the red and infrared LEDs, respectively. First, to prolong battery life, the LEDs are driven only when needed. One third of the ADG733 SPDT analog switch is used to disconnect/connect the 1.25 V voltage reference from/to each current circuit. When driving the LEDs, the ADR1581 1.25 V voltage reference is buffered by one half of the ADA4505-2; the presence of this voltage on the noninverting input forces the output of the op amp (due to the negative feedback) to maintain a level that causes its inverting input to track the noninverting pin. Therefore, the 1.25 V appears in parallel with the 20 Ω R1 or 12.4 Ω R5 current source resistor, creating the flow of the 62.5 mA or 101 mA current through the red or infrared LED as the output of the op amp turns on the Q1 or Q2 N-MOSFET IRLMS2002.

The maximum total quiescent currents for one half of the ADA4505-2, the ADR1581, and the ADG733 are 15 μ A, 70 μ A, and 1 μ A, respectively, for a total of 86 μ A current consumption (430 μ W power consumption) per circuit, which is good for a system powered by a battery. If the accuracy and temperature drift of the total design need to be improved, a more accurate and low temperature coefficient drift voltage reference and current source resistor should be used. C3 and C4 are used to improve stabilization of U1; R3 and R7 are used to provide some current limit into the U1 inverting pin; and R2 and R6 are used to slow the rise time of the N-MOSFET when it turns on. These elements may not be needed, or some bench adjustments may be required.

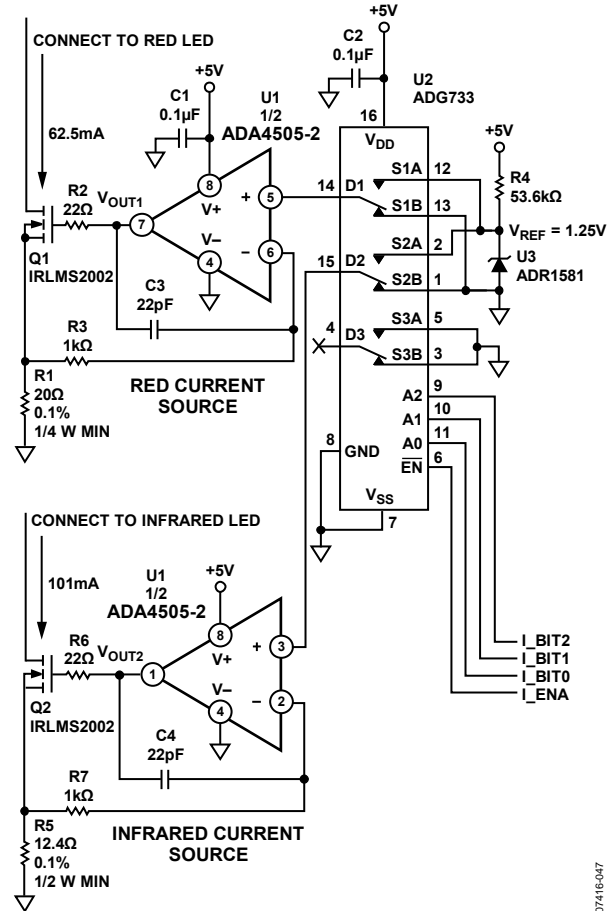
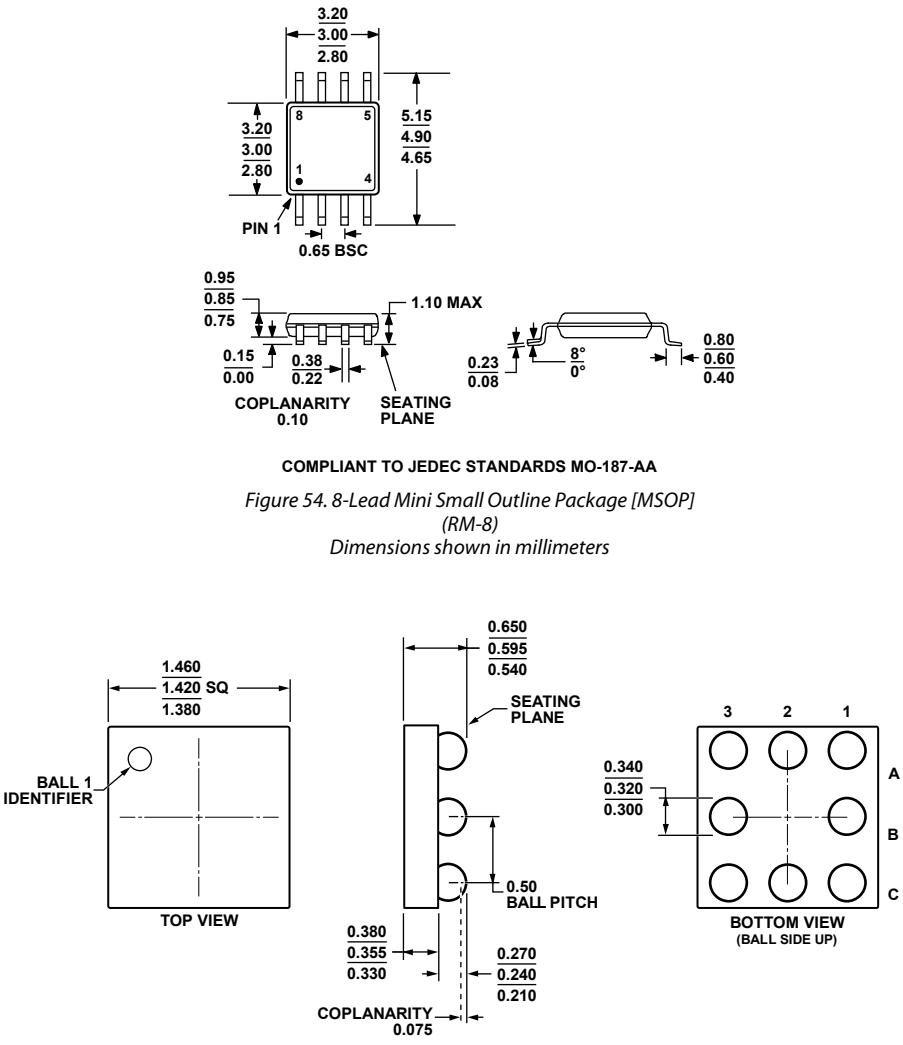
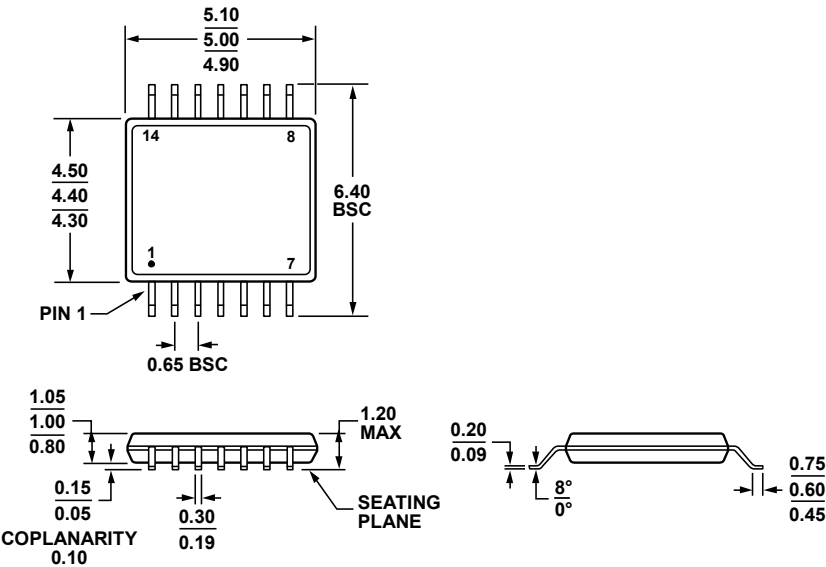


Figure 52. Pulse Oximeter Red and Infrared Current Sources Using the ADA4505-2 as a Buffer to the Voltage Reference Device

OUTLINE DIMENSIONS



011005-B



COMPLIANT TO JEDEC STANDARDS MO-153-AB-1

Figure 56. 14-Lead Thin Shrink Small Outline Package [TSSOP]
(RU-14)

Dimensions shown in millimeters

061908-A

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
ADA4505-2ACBZ-RL ¹	−40°C to +125°C	8-Ball WLCSP	CB-8-2	A21
ADA4505-2ACBZ-R7 ¹	−40°C to +125°C	8-Ball WLCSP	CB-8-2	A21
ADA4505-2ARMZ-R2 ¹	−40°C to +125°C	8-Lead MSOP	RM-8	A21
ADA4505-2ARMZ-RL ¹	−40°C to +125°C	8-Lead MSOP	RM-8	A21
ADA4505-4ARUZ ¹	−40°C to +125°C	14-Lead TSSOP	RU-14	
ADA4505-4ARUZ-RL ¹	−40°C to +125°C	14-Lead TSSOP	RU-14	

¹ Z = RoHS Compliant Part.

NOTES